Praetorian[®] L-C LCD and Camera EMI Filter Array with ESD Protection

Features

- Four, Six and Eight Channels of EMI Filtering with Integrated ESD Protection
- Pi-Style EMI Filters in a Capacitor-Inductor-Capacitor (C-L-C) Network
- ±15 kV ESD Protection on Each Channel (IEC 61000-4-2 Level 4, Contact Discharge)
- Greater than 30 dB Attenuation (Typical) at 1 GHz
- 0.50 mm Thick µDFN Package with 0.40 mm Lead Pitch:
 - 4-channel = 8-lead μDFN
 - ♦ 6-channel = 12-lead µDFN
 - ♦ 8-channel = 16-lead µDFN
- Tiny µDFN Package Size:
 - 8-lead: 1.70 mm x 1.35 mm
 - 12-lead: 2.50 mm x 1.35 mm
 - 16-lead: 3.30 mm x 1.35 mm
- These Devices are Pb-Free and are RoHS Compliant

Applications

- LCD and Camera Data Lines in Mobile Handsets
- Wireless Handsets
- LCD and Camera Modules



ON Semiconductor®

http://onsemi.com

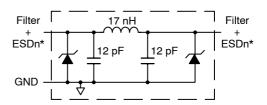






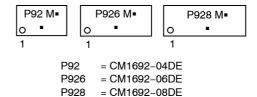
UDFN8 DE SUFFIX CASE 517BC UDFN12 DE SUFFIX CASE 517BD UDFN16 DE SUFFIX CASE 517BE

ELECTRICAL SCHEMATIC



1 of 4, 6 or 8 EMI/RFI Filter Channels with Integrated ESD Protection

MARKING DIAGRAM



M = Date Code ■ Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
CM1692-04DE	μDFN-8 (Pb-Free)	3000/Tape & Reel
CM1692-06DE	μDFN-12 (Pb-Free)	3000/Tape & Reel
CM1692-08DE	μDFN-16 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

1

^{*} See Package/Pinout Diagrams for expanded pin information.

PACKAGE / PINOUT DIAGRAMS

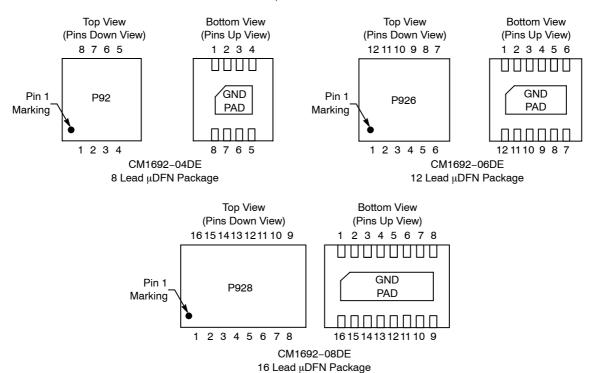


Table 1. PIN DESCRIPTIONS

De	vice Pir	1(s)			De	Device Pin(s)			
-04	-06	-08	Name	Description	-04	-06	-08	Name	Description
1	1	1	FILTER1	Filter + ESD Channel 1	8	12	16	FILTER1	Filter + ESD Channel 1
2	2	2	FILTER2	Filter + ESD Channel 2	7	11	15	FILTER2	Filter + ESD Channel 2
3	3	3	FILTER3	Filter + ESD Channel 3	6	10	14	FILTER3	Filter + ESD Channel 3
4	4	4	FILTER4	Filter + ESD Channel 4	5	9	13	FILTER4	Filter + ESD Channel 4
-	5	5	FILTER5	Filter + ESD Channel 5	-	8	12	FILTER5	Filter + ESD Channel 5
-	6	6	FILTER6	Filter + ESD Channel 6	-	7	11	FILTER6	Filter + ESD Channel 6
_	-	7	FILTER7	Filter + ESD Channel 7	-	-	10	FILTER7	Filter + ESD Channel 7
-	-	8	FILTER8	Filter + ESD Channel 8	-	-	9	FILTER8	Filter + ESD Channel 8
G	ND PAI	D	GND	Device Ground	_	_	_	-	

SPECIFICATIONS

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Units
Storage Temperature Range	-65 to +150	°C
Current per Inductor	30	mA
DC Package Power Rating	500	mW

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. STANDARD OPERATING CONDITIONS

Parameter	Rating	Units
Operating Temperature Range	-40 to +85	°C

Table 4. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
L	Channel Inductance			17		nH
C _{TOTAL}	Total Channel Capacitance	At 2.5 V DC Reverse Bias, 1 MHz, 30 mV AC	18.8	23.5	28.2	pF
С	Capacitance C1	At 2.5 V DC Reverse Bias, 1 MHz, 30 mV AC		11.8		pF
V_{DIODE}	Stand-off Voltage	I _{DIODE} = 10 μA		6.0		V
I _{LEAK}	Diode Leakage Current (Reverse Bias)	V _{DIODE} = 3.3 V		0.1	1.0	μΑ
V _{SIG}	Signal Clamp Voltage Positive Clamp Negative Clamp	(Note 3) I _{LOAD} = 10 mA I _{LOAD} = -10 mA	5.6 -1.5	6.8 -0.8	9.0 -0.4	V
V _{ESD}	In-system ESD Withstand Voltage Contact Discharge per IEC 61000-4-2 Standard, Level 4	(Notes 2 and 3)	±15			kV
R _{DYN}	Dynamic Resistance Positive Negative			2.3 0.9		Ω
f _C	Roll–off Frequency at –6 dB Attenuation Z_{SOURCE} = 50 Ω , Z_{LOAD} = 50 Ω			400		MHz

T_A = 25°C unless otherwise specified.
 ESD applied to input and output pins with respect to GND, one at a time.

^{3.} Clamping voltage is measured at the opposite side of the EMI filter to the ESD pin (i.e. if ESD is applied to pin A1 then clamping voltage is measured at pin C1). Unused pins are left open.

PERFORMANCE INFORMATION

Typical Diode Capacitance vs. Input Voltage

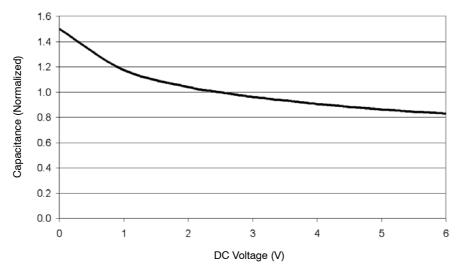


Figure 1. Filter Capacitance vs. Input Voltage (normalized to capacitance at 2.5 V DC and 25°C)

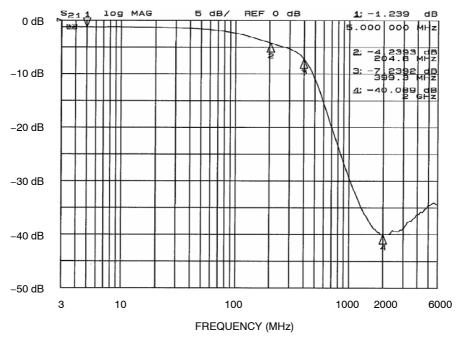


Figure 2. Typical Performance Curve





|△|010|C

PIN A1 REFERENCE

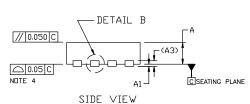
____O.10 C

UDFN8, 1.7x1.35, 0.4P CASE 517BC **ISSUE A**

DATE 11 AUG 2022

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2004.
- CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.25MM FORM THE TERMINAL TIP
- COPLANARITY APPLIES TO THE EXPOSED PADS AS WELL AS THE TERMINALS.

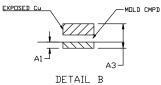


TOP VIEW

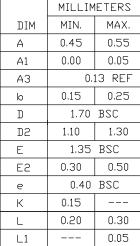
Α

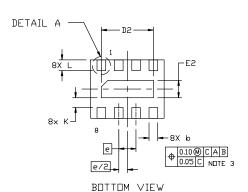
В

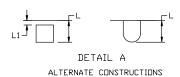
Ē



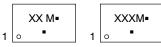
ALTERNATE CONSTRUCTIONS







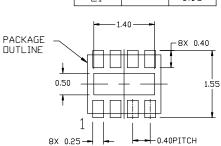
GENERIC
GENERIO
MARKING DIAGRAMS*



XXX = Specific Device Code = Date Code = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "=", may or may not be present. Some products may not follow the Generic Marking.



RECOMMENDED MOUNTING FOOTPRINT*

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

DOCUMENT NUMBER:	98AON47060E	Electronic versions are uncontrolled except when accessed directly from the Document Report Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	UDFN8, 1.7x1.35, 0.4P		PAGE 1 OF 1

onsemi and Onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries, onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

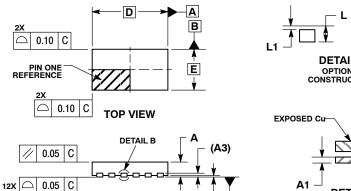




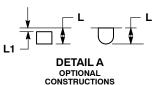
NOTE 4

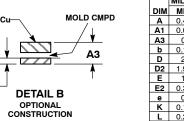
UDFN12, 2.5x1.35, 0.4P CASE 517BD **ISSUE 0**

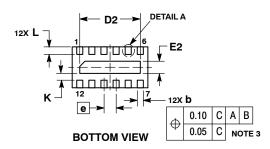
DATE 18 NOV 2009



C SEATING

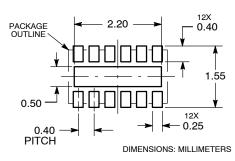






SIDE VIEW

RECOMMENDED **SOLDERING FOOTPRINT***



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND
- 0.25 mm FROM THE TERMINAL TIP.

 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS			
DIM	MIN	MAX		
Α	0.45	0.55		
A1	0.00	0.05		
А3	0.13	REF		
b	0.15	0.25		
D	2.50	BSC		
D2	1.90	2.10		
E	1.35	BSC		
E2	0.30	0.50		
е	0.40	BSC		
K	0.15			
L	0.20	0.30		
L1		0.05		

GENERIC MARKING DIAGRAM*



XX = Specific Device Code

= Month Code М = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

DOCUMENT NUMBER:	98AON47061E	Electronic versions are uncontrolled except when accessed directly from the Document Report Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	uDFN12, 2.5x1.35, 0.4p		PAGE 1 OF 1	

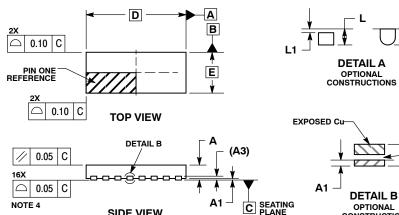
onsemi and Onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries, onsemi reserves brisefin and of 160 m are trademarked so defined values of services and of the confined values and of the values of the confined values and of the values of the confined values and of the values of the special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

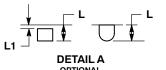
NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND



UDFN16, 3.3x1.35, 0.4P CASE 517BE **ISSUE 0** SCALE 4:1

DATE 18 NOV 2009

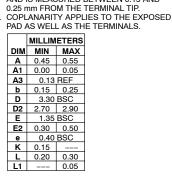


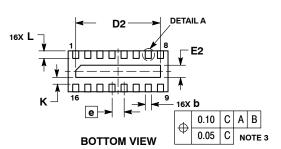


CONSTRUCTION

MOLD CMPD

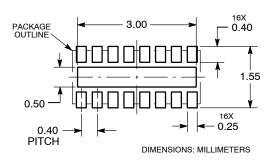
Α3





SIDE VIEW

RECOMMENDED SOLDERING FOOTPRINT*



^{*}For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



XX = Specific Device Code

= Month Code М

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

DOCUMENT NUMBER:	98AON47062E	Electronic versions are uncontrolled except when accessed directly from the Document Repos Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	UDFN16, 3.3X1.35, 0.4P		PAGE 1 OF 1

onsemi and Onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries, onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales